





Study Committee B5

Protection and Automation

10148

Requirements and Technological Trends on Stand Alone

Merging Units

Adriano Pires, Hector Leon, Lucas Groposo, Roy Mao, Ilia Voloh

GE Grid Solutions

Motivation

 Digitizing Analog CT/VT is key for Digital Substations and Merging Units are the bridge devices in between Physical (IEC61869) and Digital (IEC 61850) worlds.



Fig 1. Diagram showing the connection in between standard series

- Recently the IEC 61869 received updates consider LPITs and Merging Units, especially with IEC 61869 -9 and -13
- This work aims to discuss the impact of these new standards for Protection and Control Systems

IEC 61869-9 and its Challenges

• The IEC 61869-9 focus in the sampled values profiles

FfSsliUu

- f-Output Frame rate
- i # Current channels
- s number of ASDUs
- u # Voltage channels

IEC 61869-9 Name			Limit of channels (i + u)	Non-official Name	Application
F480052IiUu	4800	2	24	Protection Profile	Measuring and Protection
F1440056IiUu	14400	6	8	Power Quality Profile	Quality metering
F9600051IiUu	96000	1	24	D.C. Profile	D.C. Control

Tab 1. Preferred profiles according to the IEC 61869-9

 On top of these changes, the IEC 61869-9 also defines: fixed prefixes to TCTRs and TVTRs, dataset names and DO extensions to describe acquisition characteristics.

IEC 61869-13 and its Challenges

- The IEC 61869-13 focus in to define Stand-Alone Merging Unit (SAMU) especially with regards requirements for type tests and accuracy
- Accuracy is specified with different classes for measurement and protection purposes and has requirements for frequency response and temperature stability
- Type tests acceptance criteria A, B and C were clearly stated for SAMU which allows customer define their expected quality based in the standard.

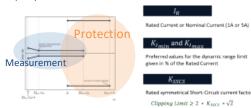
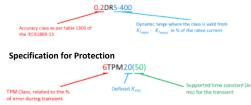


Fig 2. Diagram illustrating IEC 61869-13 concepts for specifying SAMU accuracy

Specification for Measurement



 Meet all requirements together brings challenges considering the main technologies today: Resistors or Magnetic Transformer

Parameter/Solution	Magnetic	Shunt or Resistor Divider
Isolation	Intrinsic	Necessary
Cost	\$	\$\$
Current withstands (shunt)	High	Low
Transient Performance (current)	insufficient	excellent
Size/Weight	High	Low
Magnitude error	Medium	Medium
Phase error	High	Low
Temperature introduced error	Low	High

Tab 2. Assessment of the acquisition technologies against IEC 61869-13 requirements

Impacts in P&C

- IEC 61869-9 brings more impact making the substation modelling more flexible and logical which can also bring benefits by reducing network bandwidth.
- IEC 61869-13 brings more impacts. The most onerous requirement is related to the transient response analyzed through a C-O-C-O test

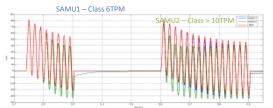


Fig 3. Simulation of a C-O-C-O with two hypothetical SAMU with different Protection classes

Conclusion

- IEC 61869 series standardized the concept of a Stand-Alone Merging Unit (SAMU), which shall help the industry to adopt the technology
- Most of the IEC 61869-9 changes have low risk of a major redesign of the system or the products, except for the new profile dedicated to DC applications.
- IEC 61869-13 brings risks to major redesign due to hardware requirements, especially with regards acquisition
- Requirements for transient response have impacts in P&C only for systems with high X/R Ration

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